

June 2007

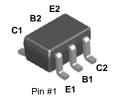
BC847BS

NPN Multi-chip General Purpose Amplifier

This device is designed for general purpose amplifier applications at collector currents to 200 mA. Sourced from Process 07.

Dual NPN Signal Transister

SC70-6 Mark: .1F



NOTE: The pinouts are symmetrical; pin 1 and pin 4 are interchangeable. Units inside the carrier can be of either orientation and will not affect the functionality of the device.

Absolute Maximum Ratings * Ta = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	50	V
V _{CES}	Collector-Base Voltage	50	V
V _{CEO}	Collector-Emitter Voltage	45	V
V _{EBO}	Emitter-Base Voltage	6.0	V
I _C	Collector Current (DC)	100	mA
T _{J,} T _{STG}	Junction Temperature and Storage Temperature	-55 ~ + 150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

Thermal Characteristics * Ta = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
PD	Total Device Dissipation	210	mW
	Derate above 25°C	1.6	mW/°C
$R \ominus JA$	Thermal Resistance, Junction to Ambient	625	°C/W

^{*}Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06".

¹⁾ These ratings are based on a maximum junction temperature of 150 degrees C.

²⁾ These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Electrical Characteristics * T_a = 25°C unless otherwise noted

Symbol	Parameter	Test Condition	MIN	MAX	Units
Off Charac	teristics				
V _(BR) CBO	Collector-Emitter Breakdown Voltage	Ic = 10 μA, Iε = 0	50		V
V _{(BR)CES}	Collector-Base Breakdown Voltage	Ic = 10 μA, Iε = 0	50		V
V _{(BR)CEO}	Collector-Base Breakdown Voltage	Ic = 10 mA, I _B = 0	45		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	I _E = 10 μA, I _C = 0	6.0		V
Ісво	Collector-Cutoff Current	Vcb = 30 V, IE = 0 Vcb = 30 V, IE = 0, TA = 150°C		15 5.0	nA μA

On Characteristics

hfe	DC Current Gain	Ic = 2.0 mA, VcE = 5.0 V	200	450	
Vce(sat)	Collector-Emitter Saturation Voltage *	$I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$ $I_C = 100 \text{ mA}, I_B = 5.0 \text{ mA}$		0.25 0.65	V V
VBE(on)	, and the second	Ic = 2.0 mA, VcE = 5.0 V Ic = 10 mA, VcE = 5.0 V	0.58	0.7 0.77	V V

^{*} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%

NOTE: All voltages (V) and currents (A) are negative polarity for PNP transistors.





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Rev. I23